



SamHop Microelectronics Corp.



STM301N

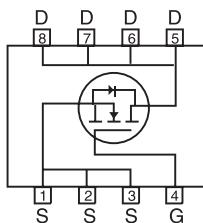
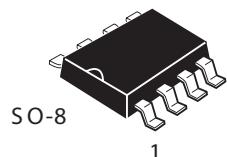
Ver1.0

## N-Channel Enhancement Mode Field Effect Transistor

PRODUCT SUMMARY		
VDSS	ID	RDS(ON) (mΩ) Max
100V	5.2A	48 @ VGS=10V
		56 @ VGS=4.5V

### FEATURES

- Super high dense cell design for low RDS(ON).
- Rugged and reliable.
- Surface Mount Package.



### ABSOLUTE MAXIMUM RATINGS ( $T_A=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter		Limit	Units
$V_{DS}$	Drain-Source Voltage		100	V
$V_{GS}$	Gate-Source Voltage		$\pm 20$	V
$I_D$	Drain Current-Continuous <sup>a</sup>	$T_A=25^\circ\text{C}$	5.2	A
		$T_A=70^\circ\text{C}$	4.2	A
$I_{DM}$	-Pulsed <sup>b</sup>		28	A
$E_{AS}$	Sigle Pulse Avalanche Energy <sup>d</sup>		156	mJ
$P_D$	Maximum Power Dissipation <sup>a</sup>	$T_A=25^\circ\text{C}$	2.5	W
		$T_A=70^\circ\text{C}$	1.6	W
$T_J, T_{STG}$	Operating Junction and Storage Temperature Range		-55 to 150	$^\circ\text{C}$

### THERMAL CHARACTERISTICS

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient <sup>a</sup>	50	$^\circ\text{C/W}$
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Details are subject to change without notice.

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## ELECTRICAL CHARACTERISTICS ( $T_A=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>OFF CHARACTERISTICS</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	100			V
$I_{DS(on)}$	Zero Gate Voltage Drain Current	$V_{DS}=80V, V_{GS}=0V$		1		$\mu A$
$I_{GSS}$	Gate-Body Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$			$\pm 100$	nA
<b>ON CHARACTERISTICS</b>						
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	1	1.5	3	V
$R_{DS(on)}$	Drain-Source On-State Resistance	$V_{GS}=10V, I_D=5.2A$		36	48	m ohm
		$V_{GS}=4.5V, I_D=5A$		39	56	m ohm
$g_{FS}$	Forward Transconductance	$V_{DS}=10V, I_D=5.2A$		18.5		S
<b>DYNAMIC CHARACTERISTICS</b>						
$C_{iss}$	Input Capacitance	$V_{DS}=25V, V_{GS}=0V$ $f=1.0MHz$		3100		pF
$C_{oss}$	Output Capacitance			165		pF
$C_{rss}$	Reverse Transfer Capacitance			130		pF
<b>SWITCHING CHARACTERISTICS</b>						
$t_{D(on)}$	Turn-On Delay Time	$V_{DD}=50V$ $I_D=1A$ $V_{GS}=10V$ $R_{GEN}=6\text{ ohm}$		45		ns
$t_r$	Rise Time			36		ns
$t_{D(off)}$	Turn-Off Delay Time			120		ns
$t_f$	Fall Time			25		ns
$Q_g$	Total Gate Charge	$V_{DS}=50V, I_D=5.2A, V_{GS}=10V$		50		nC
		$V_{DS}=50V, I_D=5.2A, V_{GS}=4.5V$		23		nC
$Q_{gs}$	Gate-Source Charge	$V_{DS}=50V, I_D=5.2A,$ $V_{GS}=10V$		4.7		nC
$Q_{gd}$	Gate-Drain Charge			11		nC
<b>DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS</b>						
$I_s$	Maximum Continuous Drain-Source Diode Forward Current			2		A
$V_{SD}$	Diode Forward Voltage	$V_{GS}=0V, I_s=2A$		0.75	1.3	V
<b>Notes</b>						
a. Surface Mounted on FR4 Board, $t \leq 10\text{sec}$ .						
b. Pulse Test: Pulse Width $\leq 300\mu s$ , Duty Cycle $\leq 2\%$ .						
c. Guaranteed by design, not subject to production testing.						
d. Starting $T_J=25^\circ C, L=0.5\text{mH}, V_{DD}=50V, V_{GS}=10V$ . (See Figure13)						

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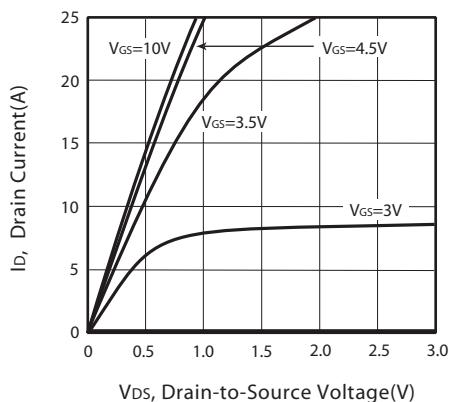


Figure 1. Output Characteristics

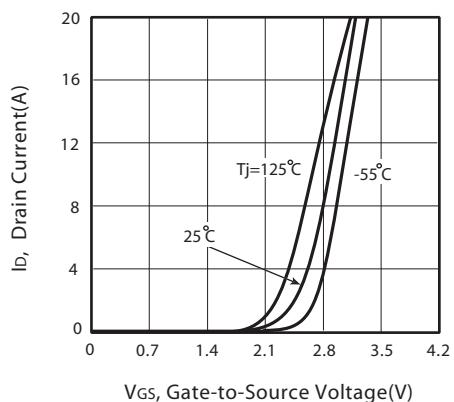


Figure 2. Transfer Characteristics

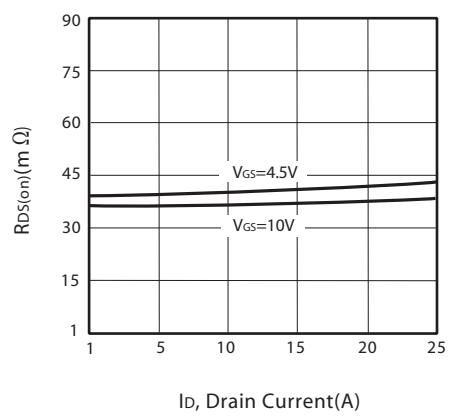


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

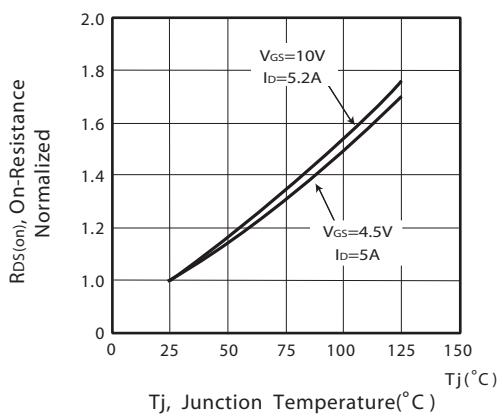


Figure 4. On-Resistance Variation with Drain Current and Temperature

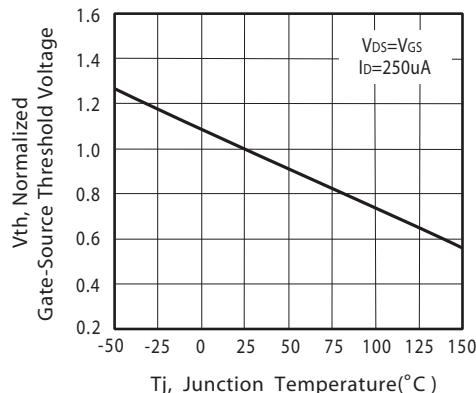


Figure 5. Gate Threshold Variation with Temperature

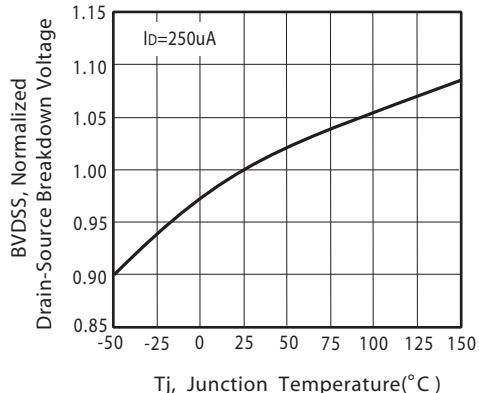


Figure 6. Breakdown Voltage Variation with Temperature

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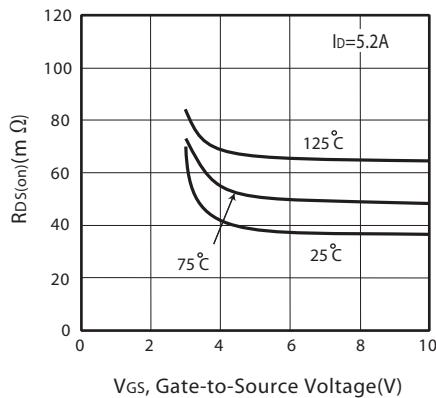


Figure 7. On-Resistance vs. Gate-Source Voltage

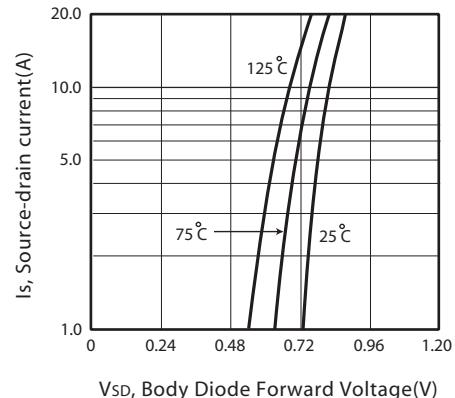


Figure 8. Body Diode Forward Voltage Variation with Source Current

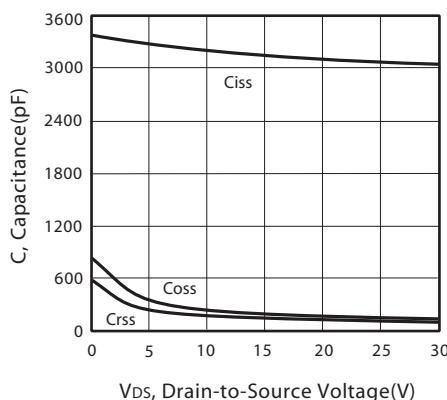


Figure 9. Capacitance

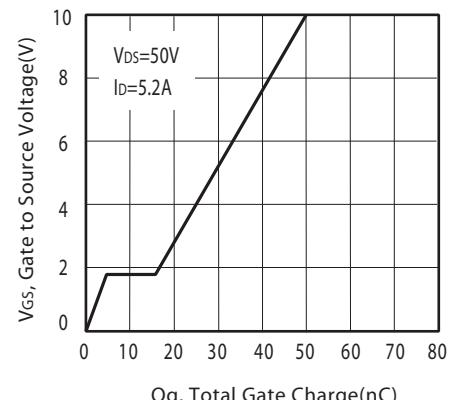


Figure 10. Gate Charge

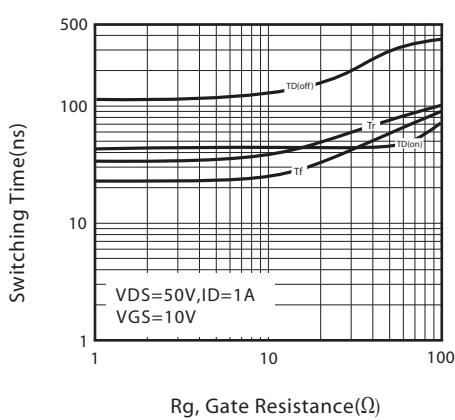


Figure 11. switching characteristics

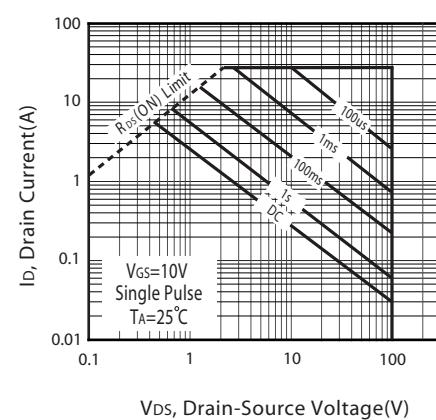
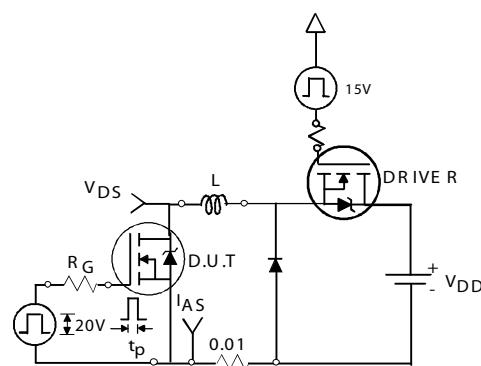


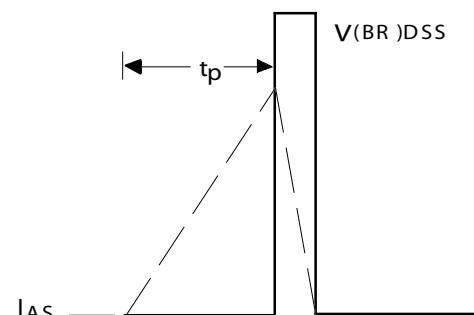
Figure 12. Maximum Safe Operating Area

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Unclamped Inductive Test Circuit

Figure 13a.



Unclamped Inductive Waveforms

Figure 13b.

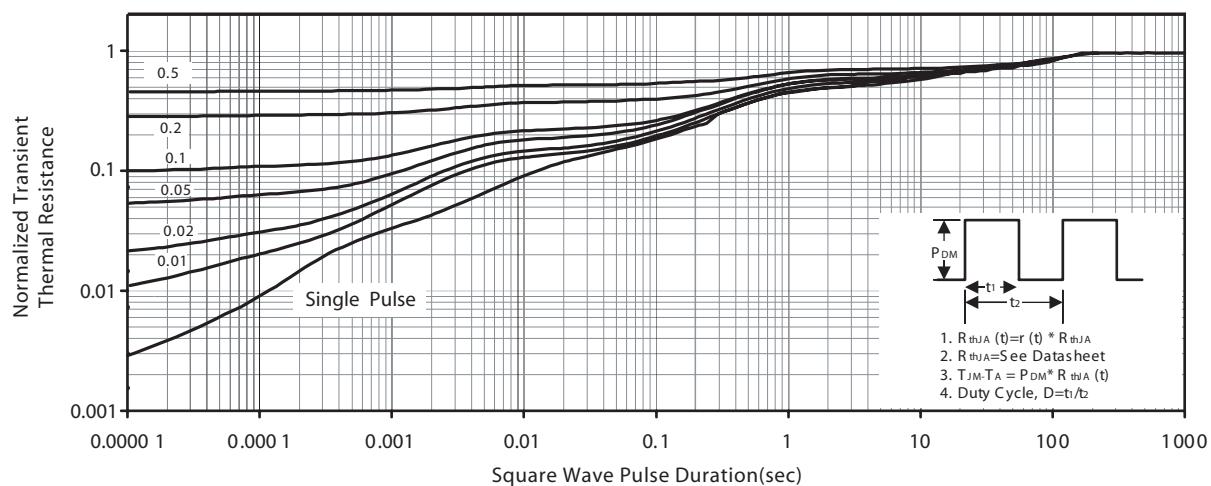
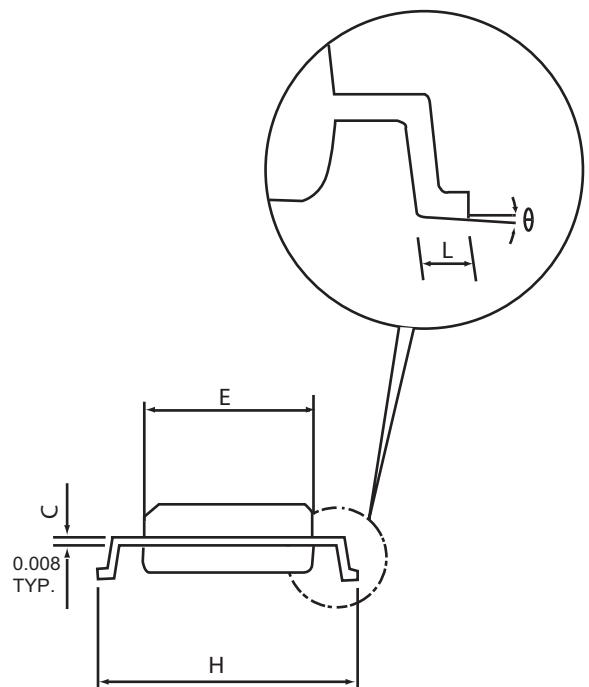
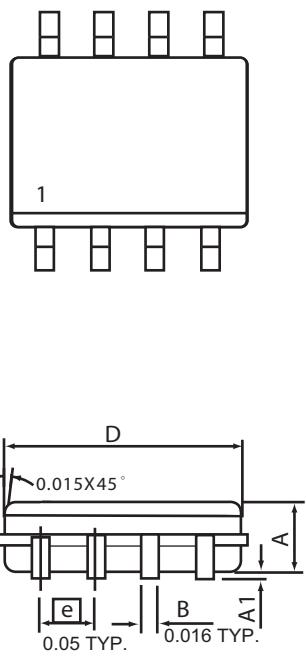


Figure 14. Normalized Thermal Transient Impedance Curve

## PACKAGE OUTLINE DIMENSIONS

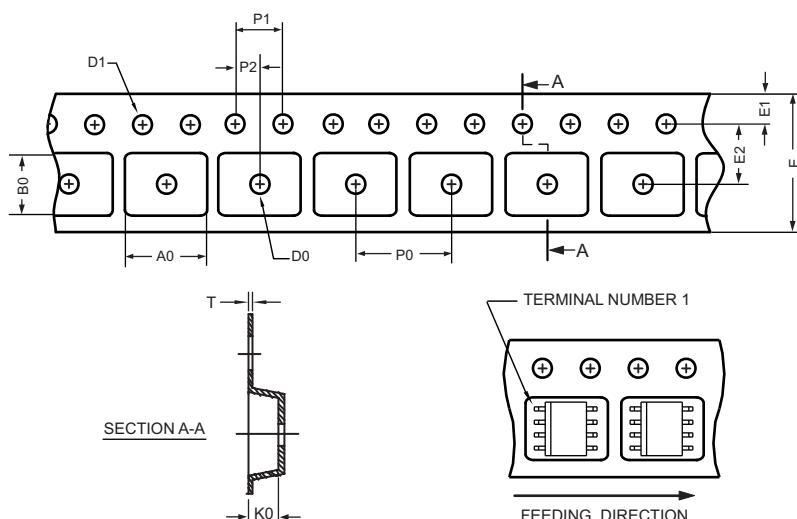
SO-8



SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	1.35	1.75	0.053	0.069
A1	0.10	0.25	0.004	0.010
D	4.80	4.98	0.189	0.196
E	3.81	3.99	0.150	0.157
H	5.79	6.20	0.228	0.244
L	0.41	1.27	0.016	0.050
θ	0°	8°	0°	8°

## SO-8 Tape and Reel Data

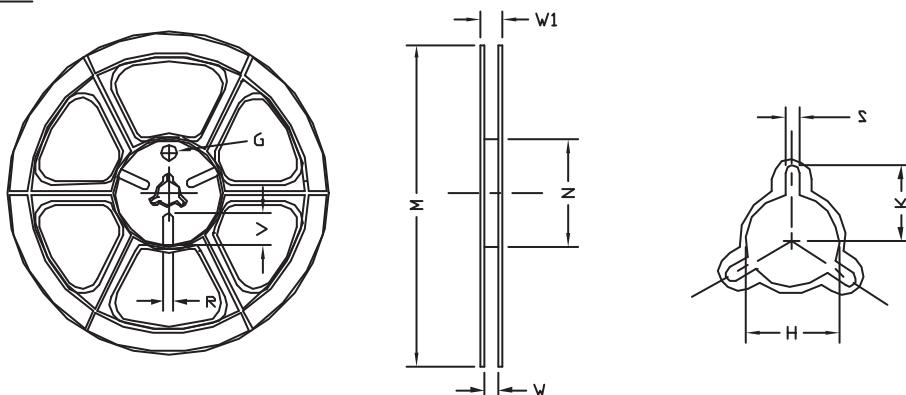
### SO-8 Carrier Tape



unit:mm

PACKAGE	A0	B0	K0	D0	D1	E	E1	E2	P0	P1	P2	T
SOP 8N 150mil	6.50 $\pm 0.15$	5.25 $\pm 0.10$	2.10 $\pm 0.10$	$\phi 1.5$ (MIN)	$\phi 1.55$ $\pm 0.10$	12.0 $+0.3$ $-0.1$	1.75 $\pm 0.10$	5.5 $\pm 0.10$	8.0 $\pm 0.10$	4.0 $\pm 0.10$	2.0 $\pm 0.10$	0.30 $\pm 0.013$

### SO-8 Reel



UNIT:mm

TAPE SIZE	REEL SIZE	M	N	W	W1	H	K	S	G	R	V
12 mm	$\phi 330$	330 $\pm 1$	62 $\pm 1.5$	12.4 $+0.2$	16.8 $-0.4$	$\phi 12.75$ $+0.15$	---	2.0 $\pm 0.15$	---	---	---